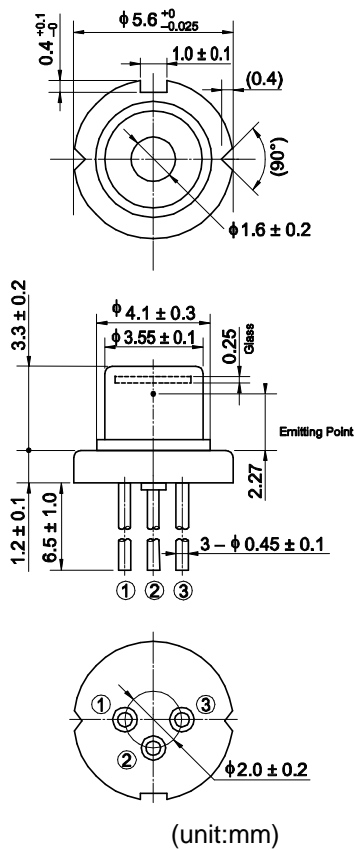


# HL65014DG

AlGaInP Laser Diode

647~650nm/150mW

## Outline



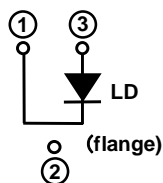
## Features:

- Wavelength selection: 647~650nm
- High optical output power: 150mW
- Operating temperature: +40°C
- Small package:  $\phi 5.6$ mm
- Single transverse mode
- TE mode oscillation

## Applications:

- Laser module
- Light source of optical equipments

## Internal Circuit



**Absolute Maximum Ratings (T<sub>c</sub>=25°C)**

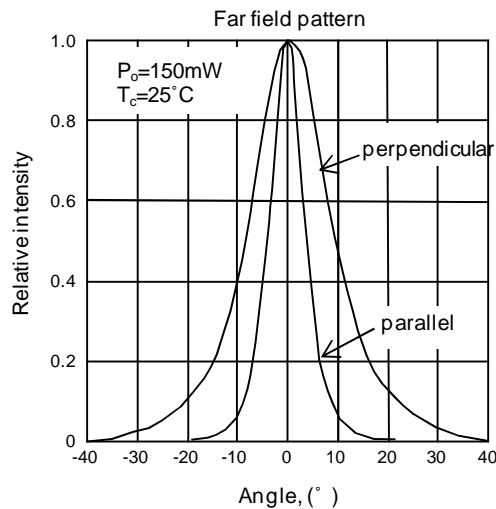
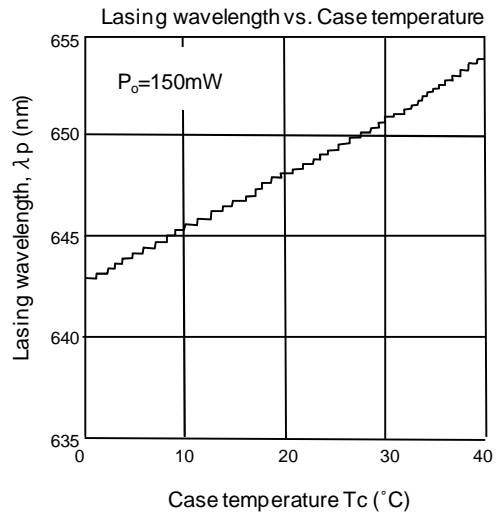
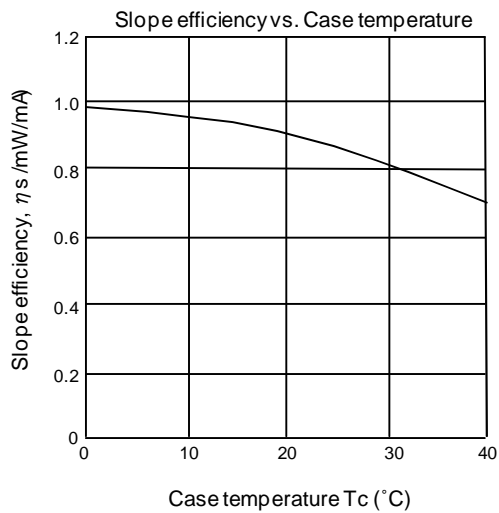
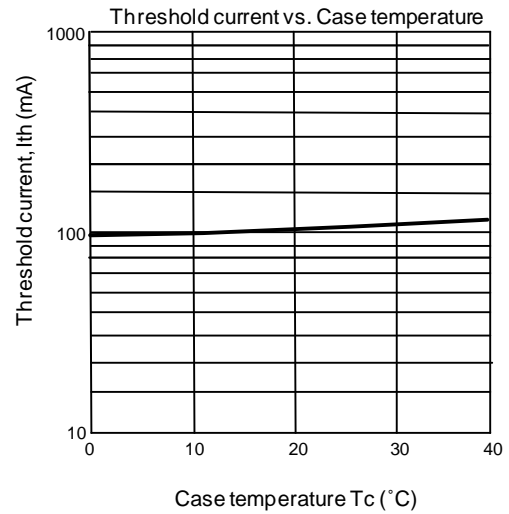
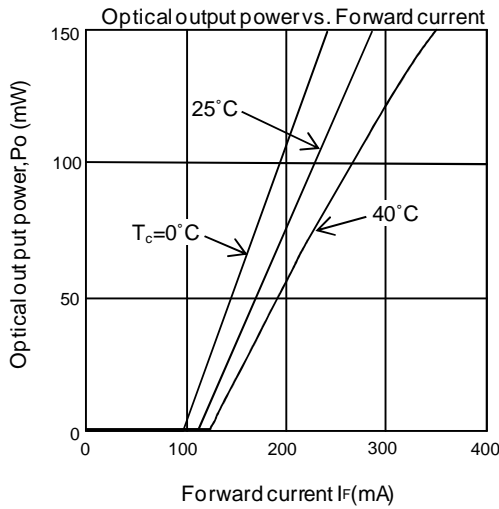
Item	Symbol	Ratings	Unit
Optical output power	P <sub>o</sub>	150	mW
LD Reverse Voltage	V <sub>R(LD)</sub>	2	V
Operating Temperature	T <sub>opr</sub>	-10 ~ +40	°C
Storage Temperature	T <sub>stg</sub>	-40 ~ +85	°C

Note: Operating temperature is defined by Case temperature "T<sub>c</sub>". High increase in temperature of LD chip itself is expected during operation due to high current density. Thus, without proper heat dissipation, it is observed that no specific output power is achieved or it results to LD degradation. It is advised that sufficient measure of heat dissipation should be taken so that LD's maximum operating temperature is not exceeded during actual operation.

**Optical and Electrical Characteristics (T<sub>c</sub>=25°C)**

Parameter	Symbol	Min	Typ	Max	Unit	Test Condition
Threshold current	I <sub>th</sub>	-	110	140	mA	-
Operating current	I <sub>op</sub>	-	280	350	mA	P <sub>o</sub> =150mW
Operating voltage	V <sub>op</sub>	-	2.6	3.0	V	P <sub>o</sub> =150mW
Beam divergence Parallel to the junction	θ <sub>//</sub>	6	9	13	°	P <sub>o</sub> =150mW
Beam divergence Perpendicular to the junction	θ <sub>⊥</sub>	13	17	22	°	P <sub>o</sub> =150mW
Lasing Wavelength	λ <sub>p</sub>	647	-	650	nm	P <sub>o</sub> =150mW

Typical Characteristic Curves



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2.This product (without violet laser diode) contains gallium arsenide (GaAs), which may seriously endanger your health even at very low doses. Please avoid treatment which may create GaAs powder or gas, such as disassembly or performing chemical experiments, when you handle the product. When disposing of the product, please follow the laws of your country and separate it from other waste such as industrial waste and household garbage.

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